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## Understanding metal organic chemical vapour deposition of monolayer WS<sub>2</sub>: the enhancing role of Au substrate for simple organosulfur precursors<sup>†</sup>

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We find that the use of Au substrate allows fast, self-limited WS<sub>2</sub> monolayer growth using a simple sequential exposure pattern of low cost, low toxicity precursors, namely tungsten hexacarbonyl and dimethylsulfide (DMS). We use this model reaction system to fingerprint the technologically important metal organic chemical vapour deposition process by *operando* X-ray photoelectron spectroscopy (XPS) to address the current lack of understanding of the underlying fundamental growth mechanisms for WS<sub>2</sub> and related transition metal dichalcogenides. Au effectively promotes the sulfidation of W with simple organosulfides, enabling WS<sub>2</sub> growth with low DMS pressure (<1 mbar) and a suppression of carbon contamination of as-grown WS<sub>2</sub>, which to date has been a major challenge with this precursor chemistry. Full WS<sub>2</sub> coverage can be achieved by one exposure cycle of 10 minutes at 700 °C. We discuss our findings in the wider context of previous literature on heterogeneous catalysis, 2D crystal growth, and overlapping process technologies such as atomic layer deposition (ALD) and direct metal conversion, linking to future integrated manufacturing processes for transition metal dichalcogenide layers.

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## Introduction

Tungsten disulfide (WS<sub>2</sub>) is a prominent material of the transition metal dichalcogenide (TMDC) family, with a characteristic layered structure of hexagonally packed metal atoms sandwiched between two layers of chalcogen atoms. Monolayer WS<sub>2</sub> exhibits a wide direct bandgap ( $E_g \approx 2$  eV), strong spin-orbit coupling and bright room-temperature photoluminescence (PL).<sup>1–4</sup> As a prototypical 2D semiconductor, WS<sub>2</sub> has raised promise in applications ranging from (opto-) electronics to spintronics and sensors.<sup>1–4</sup> These emergent applications drive the need for scalable growth of atomically thin, highly crystalline “electronic-grade” 2D layers/films,<sup>5</sup> which is distinct from

the historic focus on TMDC bulk crystal growth,<sup>6</sup> and from classic TMDC application areas such as lubricants or catalysis.<sup>7</sup> A large body of recent literature highlights the progress in such “electronic-grade” TMDC layer growth.<sup>5</sup> However, the vast parameter space and increased complexity in structure and possible mechanisms, when compared to graphene for instance, leaves the understanding of even the basic processes of TMDC layer growth still severely limited.

The currently most prevalent TMDC growth method employs powder vaporisation, typically based on the sublimation of solid precursors in a hot wall reactor, and has demonstrated large monolayer TMDC crystal domains (>100 μm) on inert substrates like SiO<sub>2</sub>/Si,<sup>8</sup> and sapphire,<sup>9</sup> as well as on metals such Ni–Ga alloys<sup>10</sup> and Au.<sup>11,12</sup> For the latter, growth has been referred to as catalytic,<sup>11</sup> analogous to graphene and nanowire growth.<sup>13,14</sup> However, the growth atmosphere is difficult to accurately control and modulate, which restricts uniformity and scalability as well as makes such powder based techniques too complex, as model systems, to advance the required fundamental understanding of crystal growth. Driven by the need for low-cost, high through-put and industrial compatibility, metal-organic chemical vapour deposition (MOCVD) and related atomic layer deposition (ALD) type tech-

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niques have emerged as prime candidates for integrated manufacturing of electronic-grade TMDC layers.<sup>5,15</sup> MOCVD of WS<sub>2</sub> thin films with average domain sizes of the order of micrometres has been demonstrated on insulating amorphous and crystalline substrates including SiO<sub>2</sub>/Si and c-plane sapphire, yet the understanding of the underlying growth mechanisms and thus how to control the layer microstructure is still in its infancy.<sup>16,17</sup> Reported MOCVD growth times for monolayer WS<sub>2</sub> are often on the order of one to tens of hours for complete coverage.<sup>18–20</sup>

Carbon contamination introduced by organic precursors is a major challenge for MOCVD, and a range of metal and chalcogen precursors have been explored to address this challenge for TMDCs.<sup>19,20</sup> Such optimisation often results in a choice of precursors that are toxic and/or difficult to handle. While standard MOCVD is based on the co-exposure of the constituent precursors, sequential exposure patterns like for ALD have also been explored.<sup>21–23</sup> However, in contrast to standard 3D materials, for TMDCs such choice of sequential exposure is less obvious, since layer-by-layer growth for 2D materials is largely dictated by their anisotropic layered crystal structure. ALD-type approaches to date have shown limited TMDC layer control and not perfect crystallinity (grain/cluster sizes  $<20$  nm).<sup>24–26</sup> The same also typically holds for ‘direct conversion’ approaches, where the metal is, for example, deposited by physical vapour deposition and then exposed to chalcogenide precursors.<sup>27–29</sup> A range of hybrid approaches tailored to optimise 2D TMDC growth, for example by post annealing,<sup>30</sup> are also emerging. In terms of understanding mechanisms, there is parallel to heterogeneous catalysis, such as hydrotreating processes like hydro-desulfurization (HDS), for which the formation of metal sulfide and the active edge and defect sites of nanoparticulate TMDC catalysts have been explored in many detailed surface science studies.<sup>31–33</sup> Such studies have also been extended to molecular beam epitaxy (MBE) and other ultra-high vacuum techniques for TMDC growth and van der Waals epitaxy.<sup>34–36</sup>

We here focus on a “deconstructed” MOCVD process for WS<sub>2</sub>, based on a simple sequential exposure pattern of low cost, low toxicity precursors, namely tungsten hexacarbonyl [THC; W(CO)<sub>6</sub>] and dimethyl sulfide [DMS; S(CH<sub>3</sub>)<sub>2</sub>]. This sequential exposure pattern, combined with cold wall reactor use, minimises precursor pre-reactions and promotes a substrate surface bound reaction path. It also enables us to explore the entire WS<sub>2</sub> growth process by *operando* X-ray photo-electron spectroscopy (XPS) in order to develop a more detailed understanding. We employ this model system to explore the effects of using a metal substrate for such MOCVD process, specifically Au. Au forms no stable compounds with either W or S in bulk form, W or S solubilities in solid Au are not significant,<sup>37</sup> and Au(111) has been widely used in surface science studies of TMDC growth.<sup>31,32</sup> Sulfidation with organo-sulfides like DMS or dimethyl disulfide (DMDS), compared to H<sub>2</sub>S, is known to result in catalysts with a higher intrinsic HDS reactivity, whereby the effective chemical potential of sulfur is lowest for DMS,<sup>38</sup> and found to affect the size and morphology

of the resulting TMDC nanoclusters.<sup>39</sup> No evidence has been found for the existence of surface or bulk carbide phases in HDS catalysts and simulations highlight that substitution of sulfur with carbon in MoS<sub>2</sub> nanoparticles is unfavourable.<sup>39</sup> There is a large body of literature on the absorption of thiols or disulfides onto Au, forming self-assembled monolayers, including reports of dissociation of organosulfides on Au.<sup>40–42</sup> This motivates us here to explore the use of Au in conjunction with DMS as sulfidation agent for MOCVD of WS<sub>2</sub> layer growth. We find that the Au substrate allows a significant reduction in the DMS pressure required to nucleate and grow WS<sub>2</sub> by MOCVD. The simple reaction scheme exhibits a self-limiting behaviour to monolayer WS<sub>2</sub>, and full coverage can be achieved by one exposure cycle of 10 minutes in total. We find the low DMS pressure also leads to a significant reduction in the carbon contamination present in as-grown WS<sub>2</sub>. We discuss our results and insights into the growth process in the context of the diverse prior literature.

## Results and discussion

The MOCVD process is ‘deconstructed’ into 2 steps with sequential exposure of metal and chalcogenide precursors as schematically highlighted in Fig. 1. Poly-crystalline Au foil (25  $\mu$ m thick; Alfa Aesar) is used as the growth substrate and is annealed and plasma cleaned prior to being loaded into the MOCVD reaction chamber (Fig. 1(b, i)). The grain size of Au is around 100  $\mu$ m. For *ex situ* experiments, a custom-built cold wall reactor (base pressure of  $2.5 \times 10^{-6}$  mbar) is used with remote sample heating *via* an IR laser (see Methods). Laser heating enables a low thermal mass for fast ramping and quenching, while at the same time minimizes cross-contamination. For *operando* XPS we employed an environmental reaction chamber with resistive heating (see Methods). The sample is initially held in vacuum at growth temperature to desorb surface contaminants and stabilize growth conditions (Fig. 1 (b, ii)), followed by a low pressure ( $5 \times 10^{-6}$  mbar) THC exposure, which we refer to as “metallization” (Fig. 1(b, iii)). THC is a well-studied precursor for W film deposition that readily decomposes at 700 °C particularly on metallic surfaces.<sup>43</sup> The second-growth step is a DMS exposure, which we refer to as “sulfidation” (Fig. 1(b, iv)). For a sub-set of experiments the sample was quenched to below 250 °C within 30 s after metallisation, before being heated back to 700 °C for the sulfidation, in order to completely decouple the process steps. However, we find that such quenching does not affect the growth outcome for the given set-ups and probed parameter space in comparison to isothermal processing at 700 °C, as indicated in Fig. 1. We find the sulfidation will happen fast enough to result in continuous WS<sub>2</sub> films with DMS pressures as low as 0.1 mbar (Fig. 2). This parameter choice was thus adopted for the *operando* XPS experiments (Fig. 3). A full characterization of WS<sub>2</sub> grown with DMS pressures varied between 0.03 and 1 mbar is presented in Fig. 5 with focus on the carbon contamination.



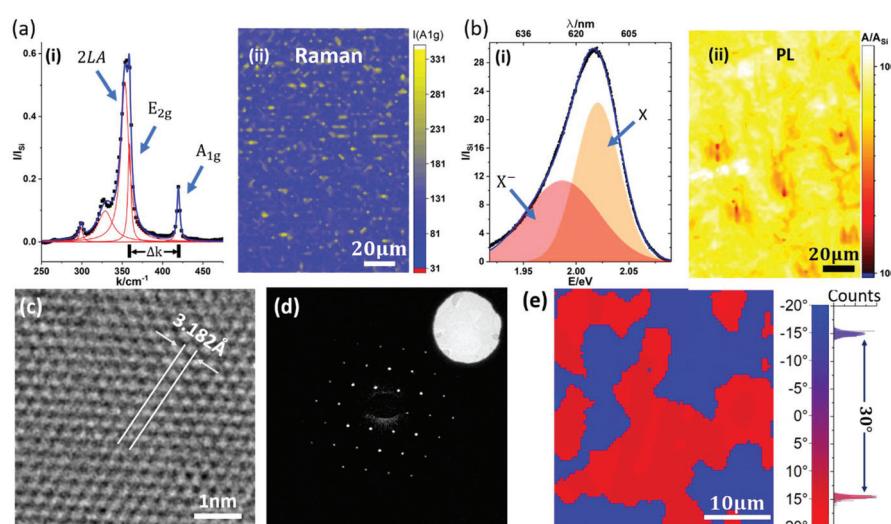
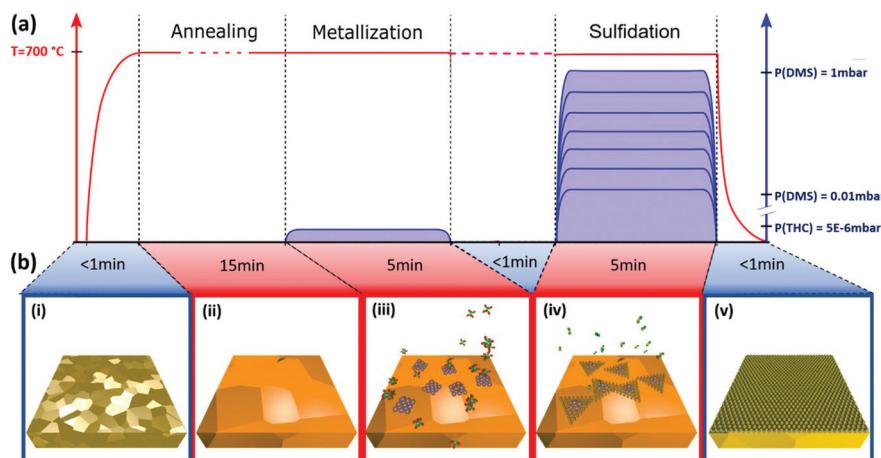
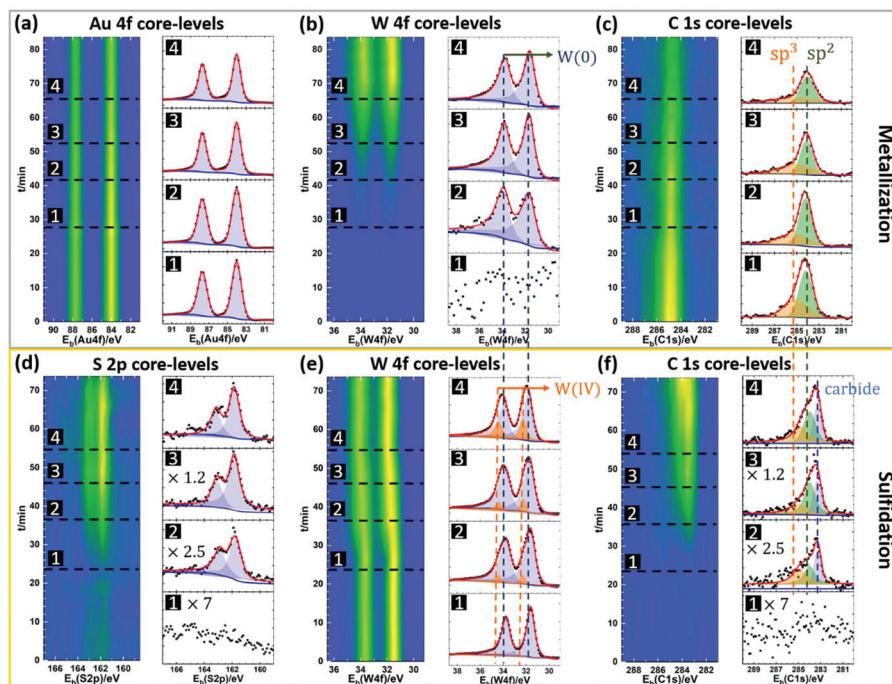


Fig. 2 Characterizations of MOCVD WS<sub>2</sub> film. (a) Raman spectroscopy of WS<sub>2</sub> film transferred onto SiO<sub>2</sub>/Si. (i) Typical Raman spectrum normalized by the Raman peak of Si. Measurement data (black dots) overlaps well with the fitted curve (blue). Some major modes (2LA, E<sub>2g</sub> and A<sub>1g</sub>) among all the Raman peaks (red) are labelled. (ii) Raman mapping of A<sub>1g</sub> peak height. (b) PL characterization of WS<sub>2</sub> film transferred on SiO<sub>2</sub>/Si substrate. (i) Typical PL spectrum normalized by the Raman peak of Si. Measurement data (black dots) overlap well with the fitted curve (blue). The exciton (X) and trion (X<sup>-</sup>) peaks are labelled. (ii) Integrated PL intensity mapping normalized by the integrated Raman intensity of Si. (c) HRTEM of the WS<sub>2</sub> film. Lattice constant is measured as ~3.2 Å. (d) SAED of WS<sub>2</sub> film. The sharp 6-fold diffraction pattern indicates good crystallinity. The inset shows bright field TEM image of the SA. (e) TEM diffraction mapping of WS<sub>2</sub> film. The average grain size of WS<sub>2</sub> of the mapped area is around 10 μm, with a bimodal crystal orientation with 30° rotation (FWHM < 1°).

Fig. 2 shows the characterization of a WS<sub>2</sub> film grown by our deconstructed MOCVD process with 0.1 mbar DMS during the sulfidation step. The WS<sub>2</sub> layer is transferred onto a SiO<sub>2</sub>/Si wafer support for Raman and photoluminescence (PL) measurements, and Quantifoil support for TEM. Fig. 2(a, i) shows a representative Raman spectrum of the WS<sub>2</sub> with E<sub>2g</sub> and A<sub>1g</sub> vibration modes measured at 356.9 cm<sup>-1</sup> and 417.6 cm<sup>-1</sup>, respectively, and with a full-width-half-maximum (FWHM) of 4.3 cm<sup>-1</sup> and 4.2 cm<sup>-1</sup>, respectively. This is in line with previously reported Raman measurements using 532 nm

laser excitation for WS<sub>2</sub> transferred onto SiO<sub>2</sub>.<sup>44-46</sup> Fig. 2(a, ii) shows a map of A<sub>1g</sub> peak height over 108 μm × 154 μm area, which confirms the continuity of the as-transferred WS<sub>2</sub> layer. The monolayer nature of as-grown WS<sub>2</sub> is further confirmed by the strong PL peak with an exciton energy of ~2.02 eV (Fig. 2 (b, i)). Fig. 2(b, ii) shows a map of normalized integrated PL intensity over the same area as the Raman mapping in Fig. 2 (a, ii). Despite some fluctuations, the PL intensity of WS<sub>2</sub> film is always orders of magnitudes stronger than the Si Raman signal (also stronger than the WS<sub>2</sub> Raman signal), consistent





**Fig. 3** Operando XPS of the MOCVD process. (a)–(c) Time-resolved Au 4f, W 4f and C 1s core-level spectra, respectively, during metallisation step. (d)–(f) Time-resolved S 2p, W 4f and C 1s core-level spectra, respectively, during the sulfidation step. From (a) to (f), the XPS intensity map over reaction time is presented on the left, while the selected spectra of each element showing different reaction stages are presented on the right.

with the monolayer character of the  $\text{WS}_2$  and the absence of  $\text{WS}_2$  multi-layer regions.<sup>3</sup> Similar to previous reports on CVD/MOCVD  $\text{WS}_2$ , a significant trion peak around 1.98 eV is detectable.<sup>47</sup>

Fig. 2(c)–(e) show high resolution transmission electron microscope (HRTEM) images and diffraction mapping results for a transferred  $\text{WS}_2$  film. The representative HRTEM image in Fig. 2(c) highlights the crystallinity of the  $\text{WS}_2$ , confirming a hexagonal lattice structure. The lattice constant is approximately 3.18 Å, which is consistent with both theory,<sup>48,49</sup> and previously reported measurement results.<sup>50,51</sup> The selected-area electron diffraction (SAED) analysis in Fig. 2(d) shows a matching clear hexagonal diffraction pattern with sharp spots. In order to determine the crystal orientation over a reasonably large area, over 200 diffraction patterns across a 40 μm × 40 μm  $\text{WS}_2$  film area were taken to construct the map shown in Fig. 2(e). We find two dominating crystal orientations rotated by  $30^\circ \pm 1^\circ$  as highlighted by the bimodal distribution (Fig. 2(e)). Although the influence of crystal orientation of the Au to the crystal orientation of  $\text{WS}_2$  is not our focus in this report, we are aware of the possible heterogeneity in  $\text{WS}_2$  arising from the poly-crystallinity of the Au substrate. The data indicates, however, an average  $\text{WS}_2$  grain size of the order of 10 μm, which compares favourably to previous literature on MOCVD TMDC materials on non-catalytic substrates with typical domain sizes on the order of a few micrometres.<sup>20</sup> The representative transfer curve of a two-terminal  $\text{WS}_2$  field effect transistor (FET) device structure is shown in Fig. S3 in ESI† with a positive light response. The MOCVD  $\text{WS}_2$  shows n-type

behaviour with a field-effect mobility of approximately  $0.5 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ , which is comparable to previously reported values.<sup>11,52</sup>

In this paper, we focus on providing insight into the reactions during the ‘deconstructed’ MOCVD process and identifying the key parameters for  $\text{WS}_2$  crystal growth control. Fig. 3 shows time-resolved *operando* XPS of the metallization and sulfidation steps. Fig. 3(a)–(c) show the Au 4f, W 4f and C 1s core level data during the metallization step. In Fig. 3(a), the Au 4f<sub>7/2</sub> core level energy is fixed to 84.0 eV allowing calibration of the other spectra. The peak position of the Au 4f<sub>5/2</sub> was 87.7 eV, consistent with a spin-orbit splitting of 3.7 eV.<sup>53</sup> During the metallization process, the intensities of the Au 4f peaks decrease over time, while the intensities of W 4f peaks increase, (Fig. 3(a) and (b)) indicating the deposition of W onto the Au surface. The binding energies (BEs) of the W 4f doublet are measured at ~31.5 eV and ~33.7 eV for the W 4f<sub>7/2</sub> and W 4f<sub>5/2</sub>, respectively. The long-tail character of the W doublet peaks are fitted well by Doniach-Šunjić (DS) line-shapes, which confirms that the deposited tungsten is metallic.<sup>54</sup> We note that a W 5p<sub>3/2</sub> component is expected around 5.5 eV to 6 eV above the W 4f<sub>7/2</sub>, but is of insufficient intensity to be resolved above the tail. To rule out the formation of tungsten carbide, the C 1s core-level is measured during the metallization process. The broad peaks at 284.2 eV (assigned to sp<sup>2</sup> carbon) and at 285.3 eV (assigned to sp<sup>3</sup> carbon) can be detected prior to exposure as shown in Fig. 3(c), consistent with amorphous carbon (a-C) species.<sup>55</sup> The C 1s peak associated with tungsten carbide is expected to have a distinctly lower BE (~283.3 eV) than what is measured during the metal-



lization process, indicating an absence of tungsten carbide at this stage.<sup>56</sup> Additionally, during THC exposure the intensity of the C 1s peak decreases without significant change in shape or position of the peak, indicating that the carbon comes from initial Au surface contamination, rather than being introduced by THC dissociation.

Fig. 3(d)–(f) shows the S 2p, W 4f and C 1s core level spectra during the sulfidation step. The formation of  $WS_2$  is marked by an increase in S 2p doublet peak intensity with the BEs of 161.8 eV (S 2p<sub>3/2</sub>) and 163.0 eV (S 2p<sub>1/2</sub>), respectively. These BEs agree with previously reported values for  $WS_2$ .<sup>57</sup> The conversion of W to  $WS_2$  is also marked by the shift and broadening of the W 4f lines during sulfidation, as shown in Fig. 3(e) and Fig. S5 in ESI.† W core level signatures from both metallic tungsten and  $WS_2$  are observable during sulfidation. The W 4f peaks for  $WS_2$  are measured at 32.2 eV for W 4f<sub>7/2</sub> and 34.4 eV for W 4f<sub>5/2</sub>, with their intensities increasing during DMS exposure, as shown in Fig. 3(e). It is interesting to note that only a fraction of W transforms into  $WS_2$  even for extended DMS exposure (Fig. 3(e)). This indicates the self-limiting nature of the tungsten sulfidation reaction on the surface of Au. Since the W 4f peaks for metallic tungsten overlap strongly with those for carbide,<sup>53</sup> we do not separate them when fitting the W 4f signals. The metal carbide and other carbon contamination in as-grown  $WS_2$  is monitored by the C 1s signal (Fig. 3(f)), which clearly increases during sulfidation. We notice a significant C 1s core level signal around 283.3 eV, in addition to the two peaks attributed to a-C in Fig. 3(c). We assign this to tungsten carbide with a distinctively lower BE. This indicates the formation of metal carbide as a side reaction and confirms DMS as the source of carbon contamination for the  $WS_2$  MOCVD process studied here. Although the sulfidation of W is self-limiting, the deposition of a-C contamination proceeds with ongoing DMS exposure (ESI, Fig. S4†).

To further study the role of the Au surface in the MOCVD process, we compare the growth result of  $WS_2$  on bare Au to that on monolayer hexagonal boron nitride (hBN) covered Au

(Fig. 4). The motivation thereby is for the hBN to suppress direct gas precursor contact with the Au surface. hBN has been used as growth substrate in previous reports and is known to remain intact after the MOCVD reaction.<sup>58</sup> We also expect hBN to affect adatom mobilities. Monolayer hBN was grown by CVD on Pt and transferred onto the Au using PMMA.<sup>59</sup> Post-growth ToF-SIMS imaging is used to map the growth results, as shown in Fig. 4(b). Fig. 4(b, i) shows a 500  $\mu$ m  $\times$  500  $\mu$ m map of the detected  $B^+$  ion species, that act as a fingerprint for the presence of the hBN film. The  $B^+$  map indicates continuous hBN coverage on Au after  $WS_2$  growth and confirms that the hBN film remains intact throughout the MOCVD process. Fig. 4(b, ii) shows a map of the detected  $WS_3^-$  ion species, used to fingerprint the presence of  $WS_2$ . We find that a  $WS_2$  film only forms on the Au surface without hBN coverage. The unreacted W will be oxidized in air at the post-growth stage, so tracking the location of the  $WO_3^-$  ion species enables us to separate the signals of unreacted W and  $WS_2$ , as shown in Fig. 4(b, iii). W is found on both the hBN covered and uncovered Au surface. This is consistent with the high chemical reactivity of the THC precursor and its ready thermal decomposition at the metallisation temperature.<sup>43</sup> The more sporadic W coverage on the hBN can be due to increased desorption and/or increased W adatom mobility. To rule out the influence of polymer residues on the hBN to the decomposition of DMS, Fig. 2(b, iv) presents a map of the detected  $C_2^-$  ion species on the surface as a fingerprint for such carbon contamination. No difference in the average carbon level between the hBN covered and uncovered Au surface is observed. We thus rule out polymer residuals as a cause of the different  $WS_2$  growth behaviour on Au and hBN covered Au. Moreover, this result also highlights that although the sulfidation rate is promoted by Au, side reactions such as the formation of carbides (see Fig. 3f) are similar on the different substrates.

Fig. 5 shows Raman spectroscopy and ToF-SIMS data, highlighting the influence of DMS partial pressures during sulfidation on the carbon contamination of as-grown  $WS_2$  on Au.

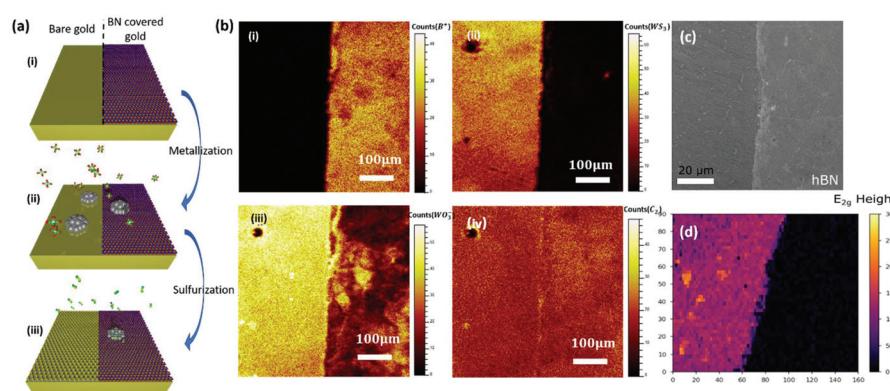
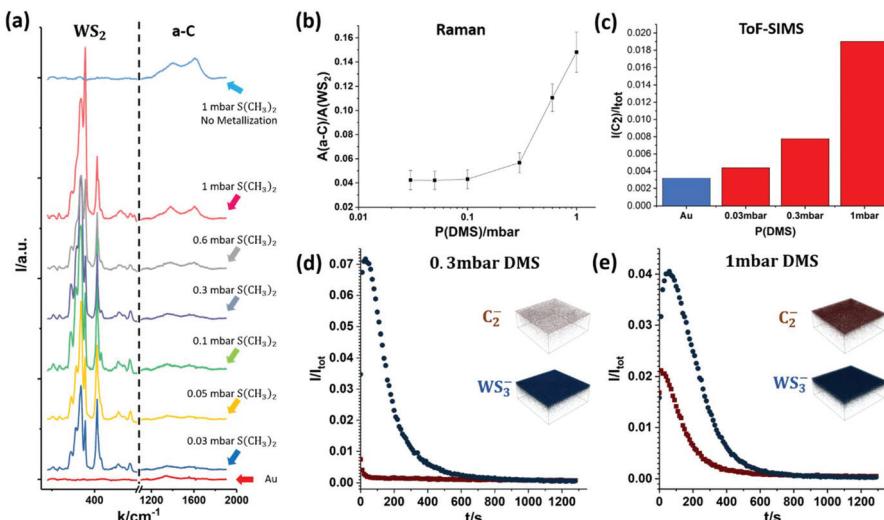


Fig. 4  $WS_2$  growth on Au partially covered by monolayer hBN. (a) Schematic of sample (i) and MOCVD procedure with metallisation (ii) and sulfidation (iii). (b) Select ToF-SIMS surface images of the sample after complete MOCVD process: (i)  $B^+$  image highlighting hBN coverage; (ii)  $WS_3^-$  image highlighting  $WS_2$  coverage; (iii)  $WO_3^-$  image to characterize W coverage; (iv)  $C_2^-$  image to characterize residual carbon. (c) SEM image of sample. No  $WS_2$  is found to grow on hBN covered Au. (d) Raman intensity map of sample.  $E_{2g}$  height is mapped near the edge of hBN after MOCVD of  $WS_2$ .





**Fig. 5** Carbon contamination introduced during sulfidation step: (a) Raman spectra of samples grown at different DMS pressures. For reference, the Raman spectra of as-annealed Au foil (red curve, bottom) and Au foil with only sulfidation at 1 mbar (light blue curve, top), but without metallization, are also included. (b) Integrated Raman peak intensity ratio between amorphous carbon (a-C) and  $WS_2$  vs. DMS pressure during sulfidation. The error bar is 5 times of the variation in each measurement. (c) Normalized ToF-SIMS  $C_2^-$  ion intensity vs. DMS pressure during sulfidation. For reference, measurement on as-annealed Au foil is also included. (d and e) ToF-SIMS depth profile and  $150\ \mu m \times 150\ \mu m$  3D depth profile images for  $C_2^-$  and  $WS_3^-$  ions for a  $WS_2$  monolayer grown on Au foil comparing low (0.3 mbar, (d)) and high (1 mbar, (e)) DMS pressures during sulfidation. Both carbon and  $WS_2$  uniformly distribute over the  $150\ \mu m \times 150\ \mu m$  region of measurement.

Fig. 5(a) plots the intensity of characteristic Raman peaks for  $WS_2$  and a-C for DMS pressures from 0.03 mbar to 1 mbar during sulfidation. For comparison, Fig. 5(a) also shows the spectra for plain, annealed Au foil (red curve, bottom) and Au foil that has undergone only sulfidation (without prior metallization) at 1 mbar (light blue curve, top). The data shows that the a-C Raman peak intensities increase with increasing partial pressures of DMS. Furthermore, Fig. 5(b) plots the integrated Raman peak intensity of a-C (from  $1100\ cm^{-1}$  to  $1900\ cm^{-1}$ ) normalized by the integrated peak intensity of  $WS_2$  (from  $250\ cm^{-1}$  to  $500\ cm^{-1}$ ). This highlights that the carbon contamination increases greatly past 0.3 mbar DMS pressure during sulfidation, which is consistent with previous literature regarding the strong contamination from DMS in MOCVD TMDC growth in the millibar pressure range.<sup>20</sup>

In order to further confirm the correlation between DMS partial pressure and carbon contamination, we employ ToF-SIMS depth profiling with a very gentle sputter rate to measure the chemical environment of monolayer  $WS_2$  on the Au surface. The depth profiles of carbon and  $WS_2$  are summarized in Fig. 5(c)–(e). Among the many carbon species detectable due to the complex decomposition of DMS, we find the  $C_2^-$  ion signal to be the most intense, and hence employ here the  $C_2^-$  ion signal as an indicator of carbon contamination. In Fig. 5(c) the  $C_2^-$  ion intensity for an as-annealed Au foil is additionally added to reference for the level of absorbed carbon contamination due to sample transfer in air. The ToF-SIMS data (Fig. 5(c)) confirms the trend seen in the Raman spectroscopy data (Fig. 5(b)) with the carbon concentration increasing with DMS partial pressure. Fig. 5(d) and (e) also show representative ToF-SIMS 3D depth profile images of

fully grown  $WS_2$  monolayers on Au foil comparing low (0.3 mbar, Fig. 5(d)) and high (1 mbar, Fig. 5(e)) DMS pressures during sulfidation. The depth profiles are normalized with respect to total ion count to allow direct comparison (see Methods). The 3D ion image insets show that for both samples the  $C_2^-$  and  $WS_3^-$  ion intensities are uniform laterally across the measured  $150\ \mu m \times 150\ \mu m$  area. However, the  $C_2^-$  ion intensity on the Au surface is significantly higher for the sample sulfidized in 1 mbar DMS. Regarding the depth dependence, the ToF-SIMS depth profiles show that for the sample grown with a low partial pressure of DMS the carbon contamination only appears on the very surface and quickly diminishes when probing further into the  $WS_2$  layer and Au (Fig. 5(d)). In contrast, for a high partial pressure of DMS, a much higher  $C_2^-$  ion intensity is detected on and away from the surface, indicating a heavier carbon contamination of the as-grown  $WS_2$ . This is further evidenced by the  $2\ mm \times 2\ mm$  surface images of the samples shown in Fig. S2 in ESI,<sup>†</sup> confirming an elevated carbon signal on the surface of the sample with high (1 mbar) DMS partial pressure.

Our simple, “deconstructed” MOCVD process allows a ‘first-order’ growth model to be developed that provides a framework for rational future process design and sets the foundation for exploring more detailed effects such as the influence of Au surface orientation. Our *operando* XPS data shows that the THC exposure leads to metallic W deposition on the Au surface. Our ToF-SIMS shows negligible levels of W and S in the post-growth Au bulk (see ESI, Fig. S1 and S2<sup>†</sup>), consistent with reported bulk phase diagrams.<sup>37</sup> Monolayer  $WS_2$  growth occurs at isothermal conditions, with no further growth or precipitation of W or S during cooling (Fig. 3). Bulk



dissolution effects are not significant to such  $WS_2$  growth. Extended THC exposure, *i.e.* more W deposition, does not lead to multi-layer  $WS_2$  growth. Rather, we observe an increasing number of particles (see ESI, Fig. S6†) in addition to the  $WS_2$  monolayer. Previous STM work on epitaxial  $MoS_2$  nucleation on Au(111) highlights the presence of amorphous Mo clusters as a result of insufficient sulfidation.<sup>32</sup> In analogy we propose excess W as the source of the observed particles here. This is consistent with the SIMS mapping in Fig. 4 showing W clusters on hBN covered Au. Since W can be detected on both hBN covered Au and bare Au, we determine that the THC decomposition is not surface selective in our reaction conditions. The W clustering indicates a reasonably high W surface mobility, which is required to achieve large  $WS_2$  crystal domain sizes. We observe no W sulfidation on top of the hBN (Fig. 4). Further, we note that as the tungsten thickness is increased the sulfidation to  $WS_2$  at the same conditions becomes less complete, and for W foil ( $\sim 25\ \mu m$ ), we can detect no 2D  $WS_2$  by Raman after sulfidation. This clearly highlights the role of the exposed Au surface in promoting sulfidation of W by DMS to form  $WS_2$ . In contrast to  $H_2S$ , which has been shown to promote metal sulfidation on top of an existing TMDC layer, thereby leading to multi-layer TMDC growth,<sup>32</sup> DMS presents a lower effective sulfur chemical potential, consistent with the lower TMDC growth rates that have been observed compared to when  $H_2S$  is used.<sup>38</sup> For our sulfidation process Au allows a significant lowering of the partial pressure of the DMS while still enabling high  $WS_2$  growth rates so that full coverage can be achieved with  $<10$  min sulfidation cycles. Importantly,  $WS_2$  growth in our process is “self-limited” to monolayer thickness. This can be rationalised with the known high affinity of Au for organosulfide adsorption leading to selectively enhanced concentrations on the Au surface.<sup>42</sup> In turn, less efficient chemisorption and high precursor desorption can be expected for inert surfaces like hBN. Thus, with the lower effective sulfur chemical potential of DMS, the supersaturation required for  $WS_2$  nucleation is only satisfied on the Au surface in our reaction conditions. Once a layer of  $WS_2$  grows and covers the Au, it prevents the DMS molecules from reaching the Au, similar to the hBN layer in Fig. 4. This leads to the observed self-limiting  $WS_2$  growth behaviour.

Thermal decomposition of DMS is reported to be slow and incomplete at our reaction temperature of  $700\ ^\circ C$ .<sup>60,61</sup> The relatively fast  $WS_2$  growth time that we observe is indicative of a clear enhancing effect of the metallic Au surface for the sulfidation with DMS. This is consistent with the known strong chemisorption of organosulfides on Au and their favourable dissociation on Au reported in heterogeneous catalysis literature.<sup>40–42</sup> There are a range of possible competing reactions including W carbide formation.<sup>62</sup> Our *operando* XPS data highlights that although the sulfidation of W is self-limiting, the deposition of a-C contamination and formation of tungsten carbide proceeds with ongoing DMS exposure (Fig. 3). This is consistent with excess W being present on top of the formed  $WS_2$  layer, similar to excess Mo clusters reported in previous STM work on top of formed  $MoS_2$  layers on Au.<sup>32</sup> It

appears that without direct contact to Au, the DMS exposure of excess W results in a different reaction pathway dominated by carbide/surface carbon formation. The result of DMS exposure of W clusters will further depend on their support, as indicated by the different behaviour on hBN (Fig. 4).

## Conclusions

We use a deconstructed MOCVD model process to understand the detailed chemical reaction during MOCVD process and discover the significant enhancing role of Au on the sulfidation step, which results  $WS_2$  monolayer growth with a simple organosulfide like DMS. This opens the possibility of using less-toxic precursors for MOCVD and ALD-type reactions, while achieving low carbon contamination and fast growth times. The much lower chalcogen precursor pressure not only yields self-limiting monolayer  $WS_2$  growth but also makes the overall process much more efficient and gives wider compatibility with standard growth reactors. The reaction scheme also opens future *operando* process characterisation opportunities, to further progress the understanding of the underlying mechanisms. *Operando* characterisation has been crucial to advancing the understanding and thus control of graphene and hBN film growth,<sup>13</sup> and we expect our results and the growth model presented here to form the basis for more detailed understanding of TMDC MOCVD. In analogy to catalytic graphene growth on Pt, this will include metal surface orientation dependent growth kinetics, and links to the challenge of cost-efficient and scalable metal substrate preparation.<sup>63,66</sup> While we here focus on Au, which requires subsequent  $WS_2$  transfer for typical opto-electronic device applications, our findings also motivate further studies on catalytic enhancement of dielectric support films, which would allow direct, transfer-free device integration. In contrast, for electro-chemical applications TMDC layers grown directly on Au can serve as powerful model system for new approaches to catalyst design.

## Methods

### ‘Deconstructed’ MOCVD growth of $WS_2$ on Au

$25\ \mu m$  Au foils with 99.985% purity from Alfa Aesar were used as the growth substrates. All as-received Au substrates were annealed for 6 hours at  $1025\ ^\circ C$  under total pressure of 800 mbar with  $H_2 : Ar = 1 : 9$ . Right before the growth, samples were treated by oxygen RIE (150 mTorr, 50 W, 5 min) to remove surface carbon contamination. All *ex situ* MOCVD growth was carried out in a cold-wall low pressure MOCVD furnace. An 808 nm continuous wave (CW) IR laser was used for sample heating. Sample temperature during growth was monitored by  $1.6\ \mu m$  IR pyrometer assuming transmission 0.9 and emissivity 0.2. The temperature measurement error was estimated as  $\sim 50\ ^\circ C$ . In all experiments, the samples were heated to  $700\ ^\circ C$  under base pressure better than  $3 \times 10^{-6}$  mbar for 15 min to



anneal and stabilize the system. After the annealing,  $\text{W}(\text{CO})_6$  (99.9%+ purity from Strem Chemicals) was sublimed at 120 °C and fed into the system as the W precursor during metallization. The partial pressure of  $\text{W}(\text{CO})_6$  was controlled by leak-valve, which allow a pressure control precision better than  $5 \times 10^{-7}$  mbar. During the metallization,  $5 \times 10^{-6}$  mbar  $\text{W}(\text{CO})_6$  was introduced to the chamber and exposed to Au foil at 700 °C for 5 min. After this,  $5.5 \times 10^{-3}$  mbar Ar is introduced to stabilize the base pressure when  $\text{S}(\text{CH}_3)_2$  (99%+ purity from Sigma Aldrich) was fed into the system as S precursor during sulfidation. The partial pressure of  $\text{S}(\text{CH}_3)_2$  was also controlled by a leak-valve.  $\text{S}(\text{CH}_3)_2$  with controlled partial pressure ranging from 0.01 mbar to 1 mbar was introduced for the sulfidation of different samples to compare its influence on  $\text{WS}_2$  produced. After sulfidation, the sample is cooled down rapidly for further characterization.

#### CVD/transfer of hBN

hBN was grown on 25  $\mu\text{m}$  thick platinum (Pt) foils (99.99%, Alfa Aesar) on a 0.5 mm tantalum (Ta) foil support as previously reported.<sup>59</sup> Prior to loading, the Pt foils were cleaned by sonication in acetone followed by iso-propanol and dried with a nitrogen gun. The growth recipe consisted of heating the sample in base pressure  $\sim 2 \times 10^{-6}$  mbar to 1000 °C then annealing at temperature for 5 minutes. Subsequently,  $1 \times 10^{-5}$  mbar partial pressure of borazine (>97%, Fluorochem) was dosed into the chamber *via* a manually operated leak valve to initiate isothermal growth for 5 minutes. A continuous monolayer BN is produced on Pt by this method. The sample was rapidly cooled under borazine atmosphere.

Electrical delamination, or ‘bubbling’, transfer of hBN is used to peel BN off from Pt.<sup>64</sup> PMMA (A4, 950k) was spun on the as grown hBN on Pt at 3000 rpm for 45 s as the scaffold layer. PMMA/BN is then peeled off from the Pt by hydrogen bubbling generated by the electrolysis of water in 0.2 M Na (OH) (aq.). The film is then rinsed and fished up by a piece of Au foil to cover half of the surface. After drying overnight, the Au piece with semi-coverage of PMMA/BN is heated to 180 °C for 30 min to soften the PMMA then soaked in acetone to remove the PMMA scaffold.

#### Transfer of $\text{WS}_2$ on Au by wet etching

PMMA (A4, 950k) was spun on the as grown  $\text{WS}_2$  on gold at 3000 rpm for 45 s. The sample is then baked at 120 °C for 3 min to evaporate the solvent of polymer.  $\text{WS}_2$  covering the backside of gold is removed by 50 W, 20 s reactive ion etching (RIE) in 150 mTorr  $\text{CF}_4$ . After the RIE, gold is etched by  $\text{KI}/\text{I}_2$  based gold etchant (Sigma-Aldrich) within 4 hours. The sample is then scooped out and rinsed in DI water for several times before being fished out by the target substrate and dried.

#### Raman/PL

Both Raman and PL spectra of samples are taken by a Renishaw inVia Raman system. The excitation laser is 20 mW, 532 nm. Single spot Raman is measured with 1% laser power 2 s exposure and accumulated 6 times. For Raman mapping,

10% laser power, 0.1 s exposure is used for each spot with a step size of 2  $\mu\text{m}$  in both x and y direction. Single spot PL is measured by 0.1% laser power 1 s exposure and accumulated 2 times. For PL mapping, 1% laser power, 0.25 s exposure is used for each spot with a step size of 2  $\mu\text{m}$  in both x and y direction. The sample is kept in the same orientation during all spectroscopy measurements to make sure that the Raman intensity of the silicon reference peak is unchanged.

For the Raman data taken from  $\text{WS}_2$  on Au, an Au baseline is taken separately and subtracted from all measured spectra. The integrated intensity for  $\text{WS}_2$  is calculated from the peak intensity from 250  $\text{cm}^{-1}$  to 500  $\text{cm}^{-1}$ . The integrated intensity for a-C is calculated from the peak intensity from 1100  $\text{cm}^{-1}$  to 1900  $\text{cm}^{-1}$ .

#### TEM

Quanti-foil TEM grid is used as the support for  $\text{WS}_2$  in the associated TEM studies. After transfer of the PMMA/ $\text{WS}_2$  onto the TEM grid, the sample is dried overnight then baked at 150 °C for 30 min to soften the polymer and increase the adherence of the  $\text{WS}_2$  to the grid. The PMMA scaffold layer is then removed by dissolving in acetone. Tecnai Osiris TEM is used for imaging and diffraction. All measurement is taken under 80 keV acceleration voltage. For diffraction mapping, selected-area electron diffraction (SAED) is taken over a grid of spots across the large area being mapped. Crystal orientation of the sample is then constructed from relative rotation between the SAEDs.

#### ToF-SIMS

*Ex situ* ToF-SIMS measurement were performed using a ToF-SIMS IV instrument (ION-TOF GmbH, Germany) at a base pressure better than  $5 \times 10^{-9}$  mbar. 25 keV  $\text{Bi}_3^+$  ions from the liquid metal ion gun (LMIG) are used for imaging. The LMIG spot size is less than 5  $\mu\text{m}$  in spectroscopy mode and is operated at a current of 0.1 pA. The surface maps (*i.e.* Fig. 4(b)) were acquired directly by randomly rastering the  $\text{Bi}_3^+$  ion beam over the surface of the sample in an area of 500  $\mu\text{m} \times 500 \mu\text{m}$  in both positive and negative ion mode. For larger area maps, successive 500  $\mu\text{m} \times 500 \mu\text{m}$  images are stitched together to create the larger image. 2D depth profiles and 3D depth profile images are acquired by cyclically analysing a 150  $\mu\text{m} \times 150 \mu\text{m}$  area (with 256  $\times$  256 pixel density and a mass spectra taken at each pixel) from the centre of a 400  $\mu\text{m} \times 400 \mu\text{m}$  sputtered region during the course of depth profiling to mitigate crater edge effects on the generated spectra. These cyclically analysed images are then combined to create a 3D image and the 2D profile. For sputtering cycles, either 10 keV  $\text{Cs}^+$  ions (100  $\mu\text{s}$  cycle time) with an ion current of 30 nA for bulk characterization, or 10 keV  $\text{Ar}_{2700}^+$  (200  $\mu\text{s}$  cycle time) with an ion current of 0.36 nA from a GCIB for near surface region characterisation, were used. All ion beams are orientated at 45° to the sample surface. No charge compensation was used during these measurements. Data processing was carried out using Surface Lab (v.6.8.99996) software, by selecting relevant



peaks in the ToF-SIMS spectra and monitoring their change in intensity over the course of the sputter profiling.

### XPS

*Operando* XPS measurements were performed at beamline B07-C of the Diamond Light Source (DLS), United Kingdom.<sup>65</sup> The environmental reaction chamber used in this study, or the 'T-cup', has a small (volume  $\sim 0.7$  L) that allows sample temperature control between room temperature and  $\sim 1000$  °C (*via* a button heater; HeatWave Labs) and local pressures between  $10^{-5}$  mbar and 30 mbar. The sample cell is attached to a differentially-pumped hemispherical electron analyser (SPECS Phoibos 150 NAP) and a differentially pumped beamline interface which enables window-less exposure to synchrotron radiation in the photon energy range 170–2800 eV. Here, a photon energy of 700 eV was used for all measurements. The beamline exit slits were opened to 800  $\mu$ m in the non-dispersive direction, and 100  $\mu$ m in the dispersive direction for XPS, which results in a spot size around 75  $\mu$ m  $\times$  200  $\mu$ m. The energy resolution of the setup is  $\sim 0.5$  eV for the energies used herein, as determined from the width of the Gaussian component of Voigt functions fitted to Au 4f spectra of gold films. The base pressure is  $\sim 8 \times 10^{-7}$  mbar before heating and  $\sim 4 \times 10^{-6}$  mbar during heating. All core level spectra were acquired with a pass energy of 20 eV and an energy step size of 0.1 eV.

The BE scale for each spectrum was referenced to simultaneously measured Au 4f<sub>7/2</sub> core levels, setting the peak position to 84.0 eV. All fittings were performed by using a Shirley background to model inelastically scattered electrons and applying either a Doniach-Šunjić (DS) line-shapes for metallic species, or a Gaussian-Lorentzian (GL) line-shapes for non-metallic species. We do not set artificial constraints on the FWHM of peaks during fitting. During the sulfidation process, we notice that the signal intensity is unstable due to the introduction of DMS. To compare the data recorded at different times, all peaks recorded during the sulfidation process were normalized by the W 4f peak intensity.

### Conflicts of interest

There are no conflicts of interest to declare.

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